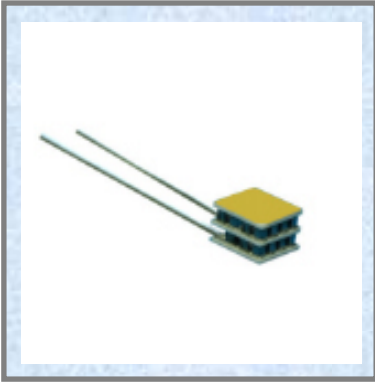


# THERMO MODULE DATA

Model **K2M-006**

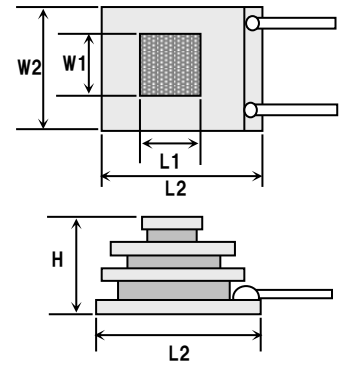
[ RoHS (EU) 2015/863 Compliant ]



Th	$\Delta T_{max}(^{\circ}C)$	$I_{max}(A)$	$V_{max}(v)$	$Q_{cmax}(w)$
27°C	92	2.6	0.9	0.8
70°C	115	2.6	1.1	0.9

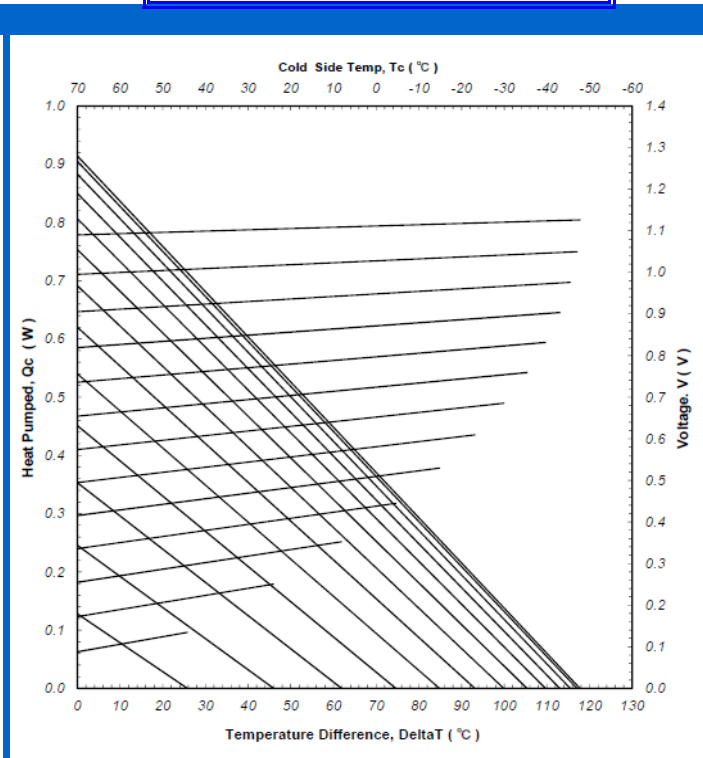
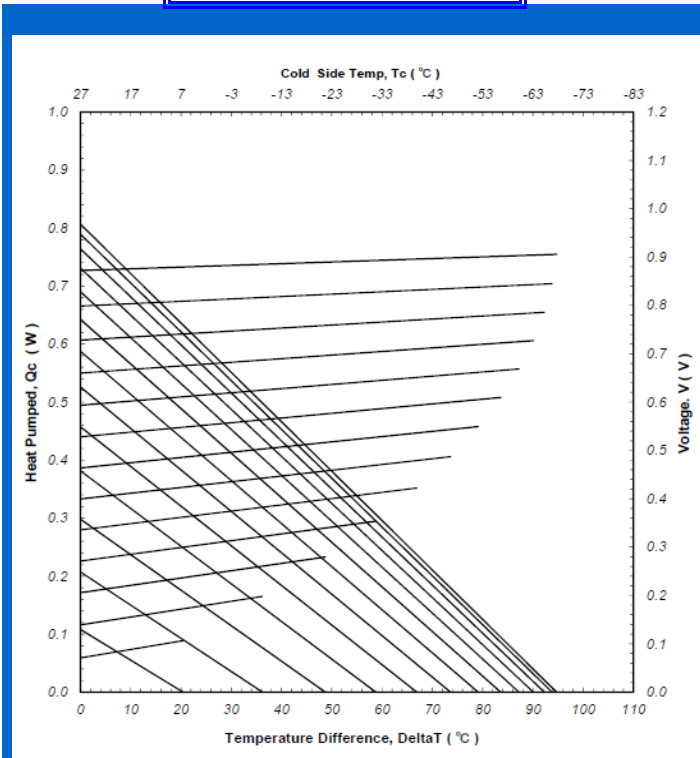
	W1	L1	W2	L2	H
Size(mm)	4.05	4.05	4.05	4.05	3.0
Tolerance(mm)	$\pm 0.2$	$\pm 0.2$	$\pm 0.2$	$\pm 0.2$	$\pm 0.2$
Metallization	Cu-Ni-Au				
Ceramic material	Alumina				
Assembly solder	SnSb (melting point : 232°C)				



## Performance Diagram

Th=27°C

Th=70°C



Ambient	Vacuum
Current value	I = 0.2~ 2.6A ( Step = 0.2 A )

**KELK Ltd.**

■ Head Office & Factory

■ Inquiry

[www.kelk.co.jp](http://www.kelk.co.jp)

3-25-1, Shinomiya, Hiratsuka-shi, Kanagawa-ken, 254-8543, Japan

Phone: +81-463-22-8724 Fax: +81-463-22-3692

<https://www.kelk.co.jp/english/contact/>

Phone: +81-463-23-3697 Fax: +81-463-24-6749